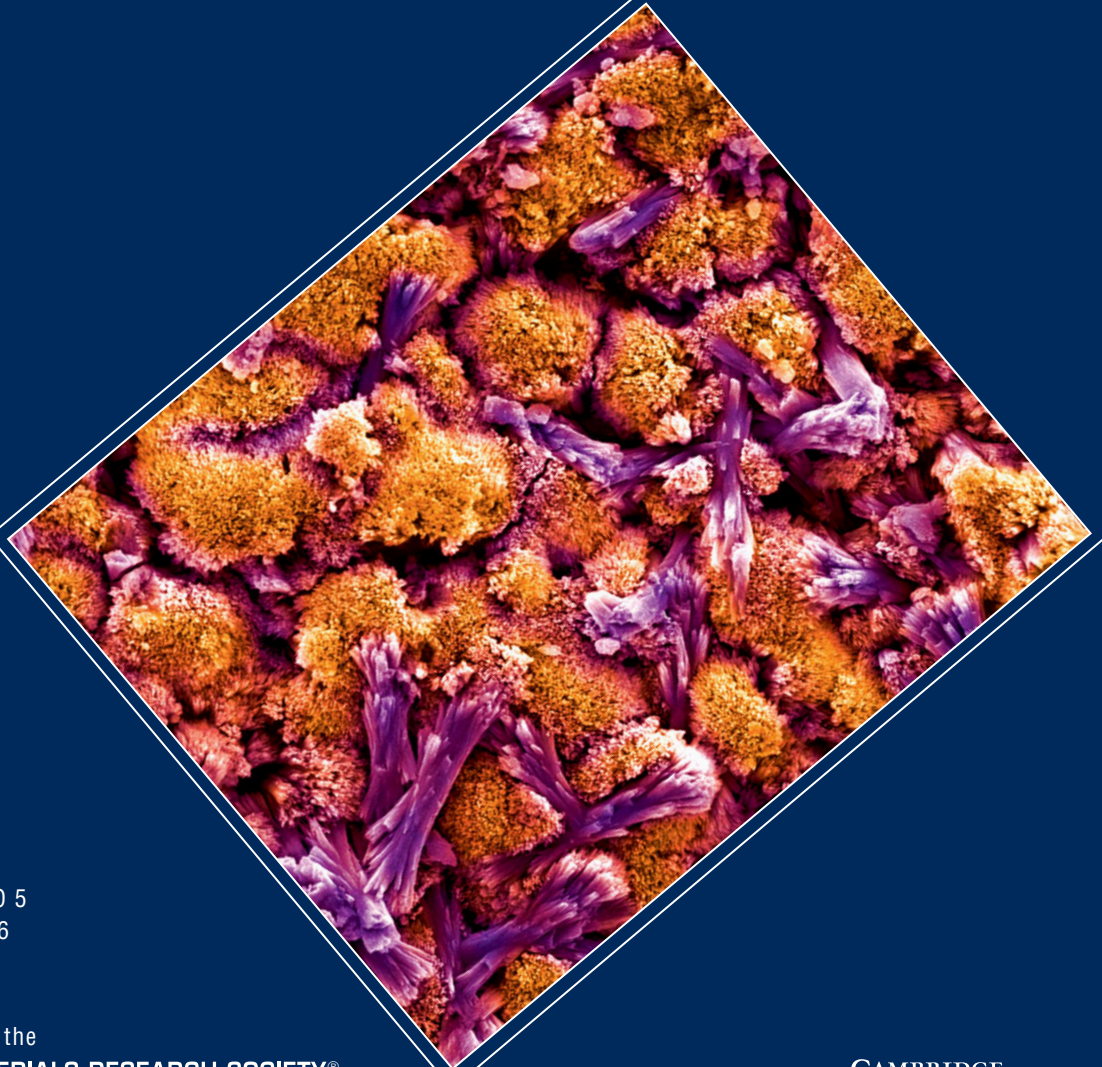




**jmr** Journal of  
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Cover: Images of the newly grown layer after remineralization in LRAP-CS hydrogel for 14 days. [K. Mukherjee, Q. Ruan, D. Liberman, S. White, J. Moradian-Oldak. Repairing Human Tooth Enamel with LRAP-chitosan hydrogel. p. 556].

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